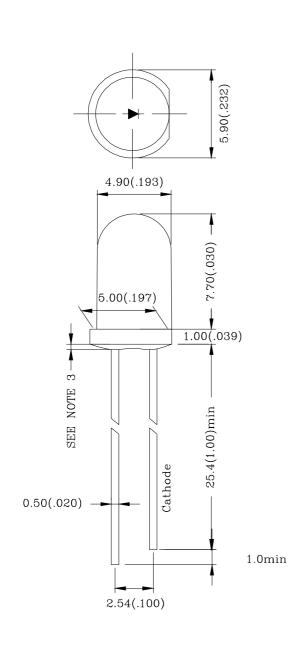
DATA SHEET PART NO.: LRR5UW5C188G-JB REV: <u>A/0</u> CUSTOMER'S APPROVAL: DCC: DRAWING NO. : DS-G-35-17-0034 DATE: 2017-06-24 Page: 1

5.0 mm DIA LED LAMP LRR5UW5C188G-JB

PACKAGE DIMENSIONS



MATERIALS
Epoxy Resin
Sn Plating iron Alloy

Note:

- 1.All Dimensions are in millimeters.
- 2.Tolerance is ±0.25mm(0.010 ") Unless otherwise specified.
- 3.Protruded resin under flange is 0.6mm(0.024 ") max.
- 4.highlight≥3000V the led can withstand the max static level when assembling or operation (HBM).

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FEATURES

- * High-brightness
- * High reliability
- * Low-voltage characteristics
- * Narrow view angle
- * Pb FREE Products
- * RoHS Compliant

CHIP MATERIALS

- * Dice Material : GaInN/GaN
- * Light Color : Banana Yellow
- * Lens Color : WATER CLEAR

ABSOLUTE MAXIMUM RATING:(Ta=25°C)

SYMBOL	DESCRIPTION	Banana Yellow	UNIT
PD	Power Dissipation Per Chip	120	mW
VR	Reverse Voltage Per Chip	5	V
lF	Average Forward Current Per Chip	30	mA
IPF	Peak Forward Current Per Chip (Duty $-0.1,1$ KHz)	100	mA
-	Derating Linear From 25°C Per Chip	0.40	mA/°C
Topr	Operating Temperature Range	-25°C to 85°C	
Tstg	Storage Temperature Range	-25°C to 85°C	

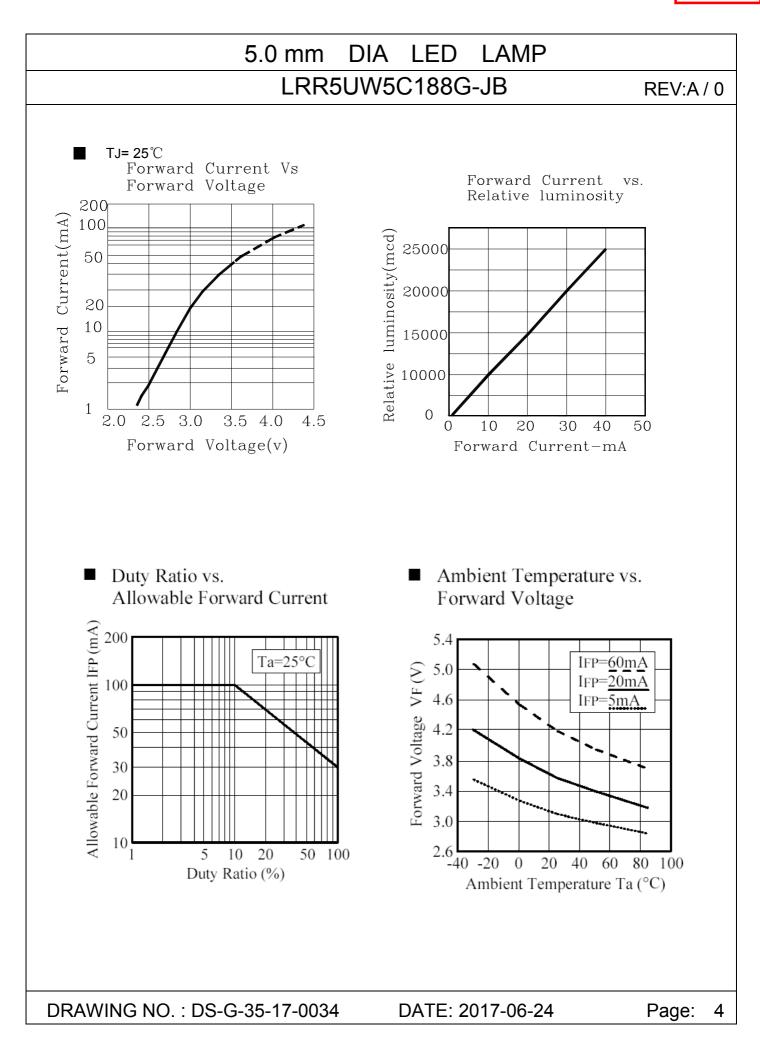
ELECTRO-OPTICAL CHARACTERISTICS:(Ta=25°C)

SYMBOL	DESCRIPTION	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
VF	Forward Voltage	IF = 20mA		2.9	4.0	V
IR	Reverse Current	VR = 5V			100	μA
201/2	Half Intensity Angle	IF = 20mA		15		deg
١v	Luminous Intensity	IF = 20mA		15000		mcd
Х	Chromoticity Coordinates	IF = 20mA		0.47		
Y	Chromaticity Coordinates	IF = 20mA		0.53		

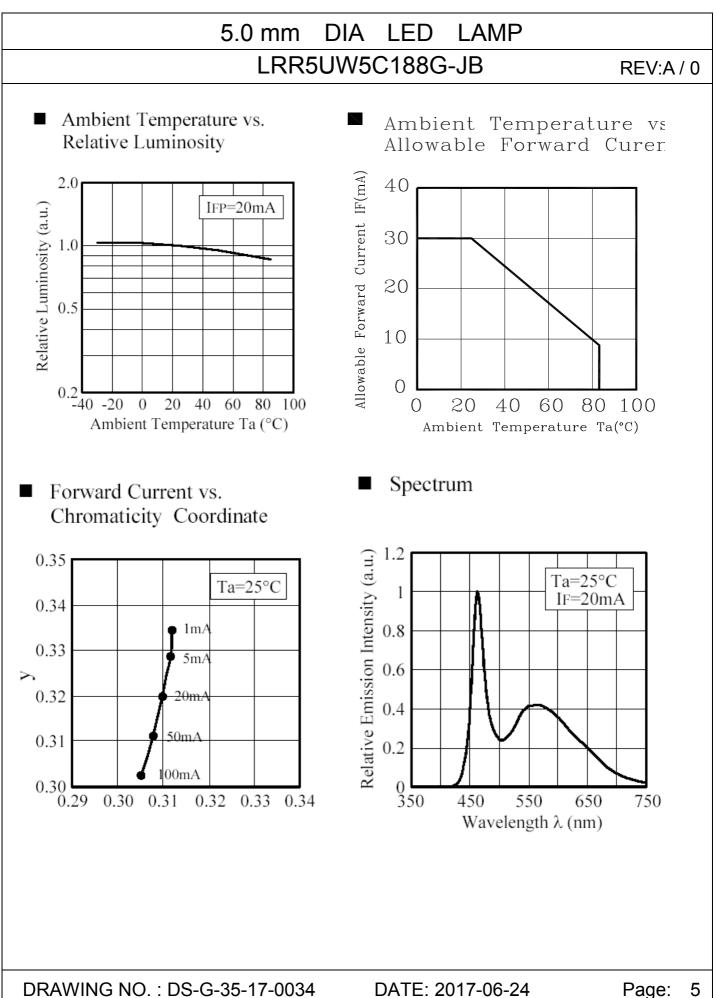
DRAWING NO. : DS-G-35-17-0034

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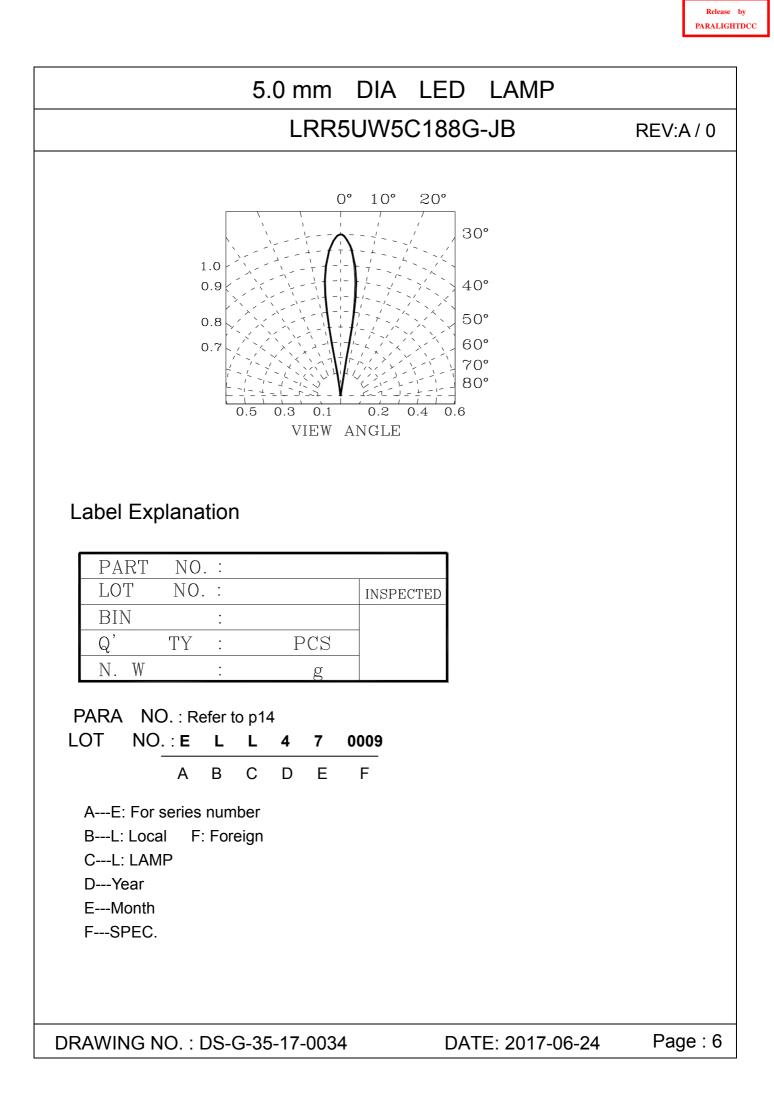
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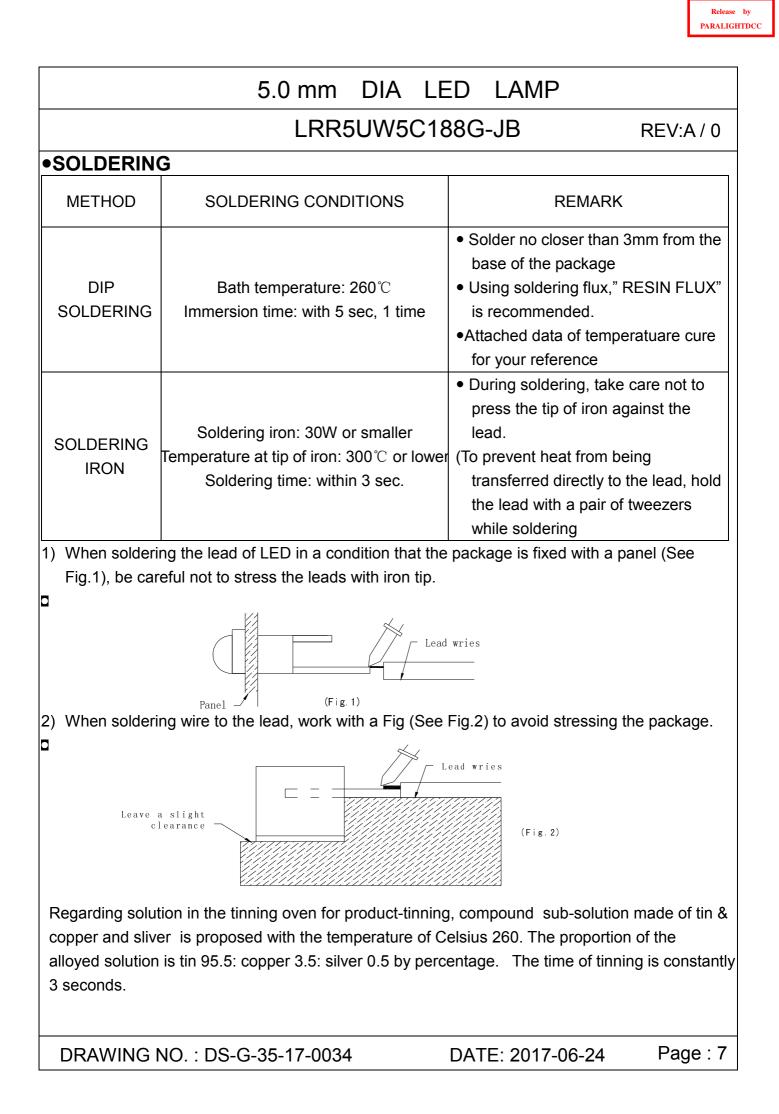


Release by PARALIGHTDCC



Release by PARALIGHTDCC



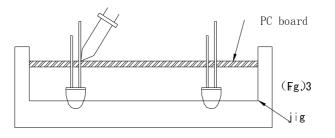


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 Similarly, when a jig is used to solder the LED to PC board, take care as much as possible to avoid steering the leads (See Fig.3).



- 4) Repositioning after soldering should be avoided as much as possible. If inevitable, be sure to preserve the soldering conditions with irons stated above: select a best-suited method that assures the least stress to the LED.
- Lead cutting after soldering should be performed only after the LED temperature has returned to normal temperature.

• STORAGE

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- 1) The LEDs should be stored at 30° C or less and 70% RH or less after being shipped from PARA and the storage life limits are 3 months .
- 2) PARA LED lead frames are comprised of a stannum plated iron alloy. The silver surface may be affected by environments which contain corrosive gases and so on. Please avoid conditions which may cause the LEDs to corrode, tarnish or discolor. This corrosion or discoloration may cause difficulty during soldering operations. It is recommended that the LEDs be used as soon as possible.
- Please avoid rapid transitions in ambient temperature, especially, in high humidity environments where condensation can occur.

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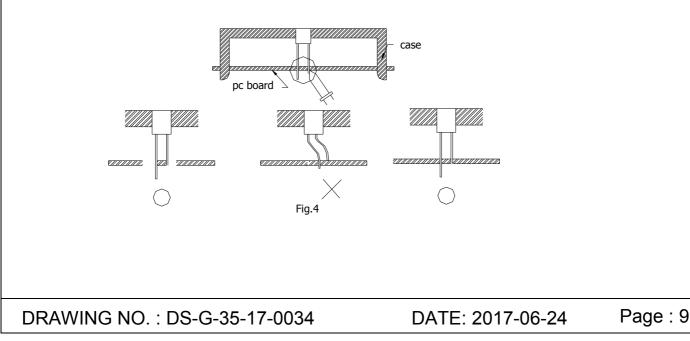
Release by PARALIGHTDCC

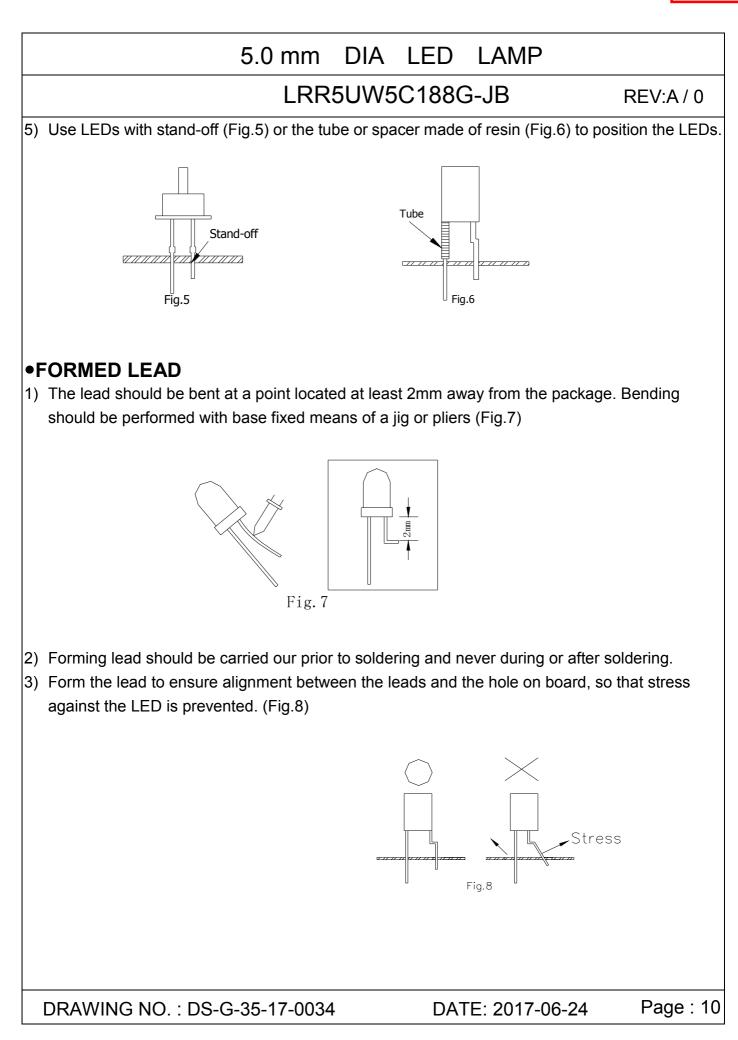
• STATIC ELECTRICITY

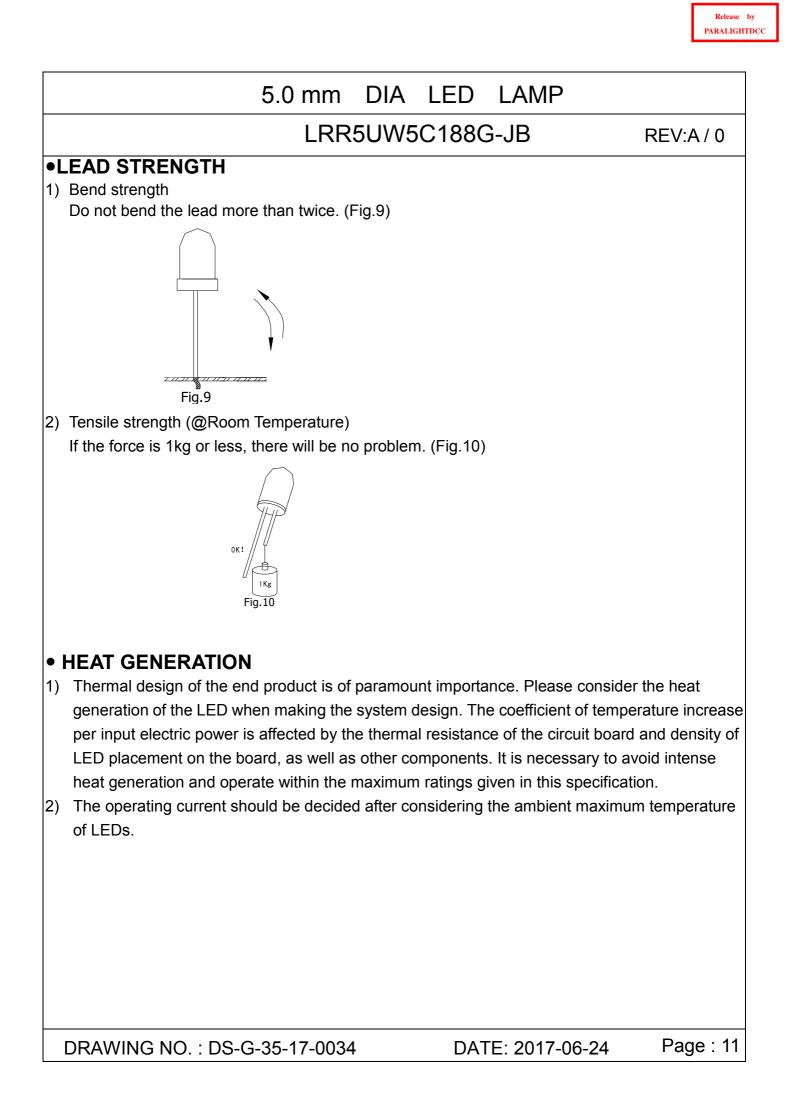
- Static electricity or surge voltage damages the LEDs.
 It is recommended that a wrist band or an anti-electrostatic glove be used when handling the LEDs.
- All devices, equipment and machinery must be properly grounded. It is recommended that measures be taken against surge voltage to the equipment that mounts the LEDs.
- 3) When inspecting the final products in which LEDs were assembled, it is recommended to check whether the assembled LEDs are damaged by static electricity or not. It is easy to find static-damaged LEDs by a light-on test or a VF test at a lower current (below 1mA is recommended).
- 4) Damaged LEDs will show some unusual characteristics such as the leak current remarkably increases, the forward voltage becomes lower, or the LEDs do not light at the low current . Criteria : (VF>2.0V at IF=0.5mA)

•LED MOUNTING METHOD

4) When mounting the LED by using a case, as shown Fig.4, ensure that the mounting holds on the PC board match the pitch of the leads correctly-tolerance of dimensions of the respective components including the LED should be taken into account especially when designing the case, PC board, etc. to prevent pitch misalignment between the leads and board holes, the diameter of the board holes should be slightly larger than the size of the lead. Alternatively, the shape of the holes should be made oval. (See Fig.4)







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•CHEMICAL RESISTANCE

- 1) Avoid exposure to chemicals as it may attack the LED surface and cause discoloration.
- 2) When washing is required, refer to the following table for the proper chemical to be sued.
- (Immersion time: within 3 minutes at room temperature.)

SOLVENT	ADAPTABILITY
Freon TE	\odot
Chlorothene	\times
Isopropyl Alcohol	\odot
Thinner	\times
Acetone	\times
Trichloroethylene	\times

NOTE: Influences of ultrasonic cleaning of the LED resin body differ depending on such factors as the oscillator output, size of the PC board and the way in which the LED is mounted. Therefore, ultrasonic cleaning should only be performed after confirming there is no problem by conducting a test under practical.

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 \odot --Usable \times --Do not use.

•OTHERS

- 1) Care must be taken to ensure that the reverse voltage will not exceed the absolute maximum rating when using the LEDs with matrix drive.
- 2) Flashing lights have been known to cause discomfort in people; you can prevent this by taking precautions during use. Also, people should be cautious when using equipment that has had LEDs incorporated into it.
- 3) The LEDs described in this brochure are intended to be used for ordinary electronic equipment (such as office equipment, communications equipment, measurement instruments and household appliances). Consult PARA's sales staff in advance for information on the applications in which exceptional quality and reliability are required, particularly when the failure or malfunction of the LEDs may directly jeopardize life or health (such as for airplanes, aerospace, submersible repeaters, nuclear reactor control systems, automobiles, traffic control equipment, life support systems and safety devices).
- 4) User shall not reverse engineer by disassembling or analysis of the LEDs without having prior written consent from PARA. When defective LEDs are found, the User shall inform PARA directly before disassembling or analysis.
- 5) The formal specifications must be exchanged and signed by both parties before large volume purchase begins.
- 6) The appearance and specifications of the product may be modified for improvement without notice.

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Bin Code List:

Luminous Intensity(IV), Unit:mcd@20mA		
Bin Code	Min	Max
NB	9710	11330
OA	11330	13595
OB	13595	15860
PA	15860	19030
PB	19030	22200

Tolerance of each bin are±10%

Forward Voltage (VF), Unit:v@20mA		
Bin	Code	Min
М	2.70	2.80
Ν	2.80	2.90
0	2.90	3.00
Р	3.00	3.10
Q	3.10	3.20

Tolerance of each bin are $\pm 0.1 \text{Volt}$

	CCT	
CCT1	2500-3000	
CCT2	3000-3500	
Measurement uncertainty of the color coordinates		

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